Appl. No. 09/764,196

Amdt. dated September 28, 2004

Reply to Office Action of June 30, 2004

Amendments to the Specification:

Please replace the paragraph extending from page 1, line 26 to line 32, with the following rewritten paragraph:

To form the image sensor assembly, the image sensor was mounted to a printed circuit mother board. After the image sensor was mounted, a housing was mounted around the image sensor and to the print printed circuit mother board. This housing provided a seal around the image sensor, while at the same time, supported a window above the image sensor.